## 502733709 03/21/2014

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2780315

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KYOUNG SANG YOO	03/13/2014
MYUNG GU KANG	03/13/2014

#### **RECEIVING PARTY DATA**

Name:	Pantech Co., Ltd.	
Street Address:	Pantech Bldg., I-2, DMC, Sangam-dong	
Internal Address:	Mapo-gu	
City:	Seoul	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	121-792	

## **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14222090

#### CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	P5302US00
NAME OF SUBMITTER:	SOK K. HONG
SIGNATURE:	/sok k. hong/
DATE SIGNED:	03/21/2014
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 2** 

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PATENT REEL: 032500 FRAME: 0566

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### ASSIGNMENT SERVING AS DECLARATION PER 37 C.F.R. § 1.63(e)

	As a below named in	wentor and Assignor, I declar	e that:
	Th <b>is assignment a</b> nd	i declaration are directed to:	
	ANTENNA AS CON ("Application"), which		ERMINAL INCLUDING MULTIBAND Itomey docket number <u>P5302US00</u> filed <u>March 29, 2013</u> .
	☐ As am	rended on	(if applicable);
	The above-identified	Application was made or auti	norized to be made by me.
n the .	I believe that I am the Application.	e original inventor or an origin	al joint inventor of a claimed invention
ounist ooth.	I hereby acknowledg nable under 18 U.S.C.	ie that any wiliful false statemi § 1001 by fine or imprisonme	ent made in this declaration is nt of not more than five (5) years, or
			useful processes, machines, articles of ts thereof ("invention") disclosed in the
<b>O</b> '.	Whereas, Assignor of	desires to convey all rights, t	itles, and interests in and to the same
		PANTECH CO., LTD. Pantech Bldg., I-2, DMC Sai Mapo-gu Seoul, 121-792 Republic of Korea	ngam-dong

PANTECH CO., LTD. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including



Docket No. P5302US00

(without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.

Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Inventor and Assignor has hereunto set hand and seal.

First Inventor's and Assignor's Name:	Kyoung Sang YOO
Address:	Pantech Bidg., I-2, DMC Sangam-dong, Mapo-gu Seoul, 121-792 Republic of Korea
First Inventor's and Assignor's Signature:	
Date:	25/4.2./2
Second Inventor's and Assignor's Name:	Myung Gu KANG
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Second Inventor's and Assignor's Signature:	
Date:	s-014, 3, 13

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**RECORDED: 03/21/2014**